700W, 50V High Power RF LDMOS FETs

Description

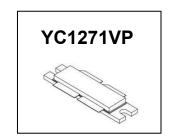
The YC1271VP is a 700-watt, high performance, internally matched LDMOS FET, designed for multiple applications with frequencies 960 to 1215MHz.

It is featured for high power and high ruggedness, suitable for Industrial, Scientific and Medical application, as well as Avionics applications.

It is recommended to use this device under pulse condition only.

Typical Performance (on Yingtron's test fixture with device soldered): Vds = 50 V, Idq
= 100 mA, Pulse width:100uS, duty cycle: 10%,

| Freq(MHz) | P3dB(dBm) | Gain(dB) | EFF(%) |
|-----------|-----------|----------|--------|
| 960 | 60.4 | 13.8 | 46.1 |
| 1000 | 60.6 | 15.1 | 51.3 |
| 1030 | 60.4 | 15.2 | 53.5 |
| 1050 | 60.2 | 15.1 | 53.9 |
| 1090 | 59.7 | 14.6 | 52.4 |
| 1100 | 59.6 | 14.4 | 52.1 |
| 1150 | 59.3 | 13.7 | 48.3 |
| 1200 | 59.3 | 13.6 | 46.9 |
| 1215 | 59.2 | 13.7 | 46.0 |



Features

- · High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Internally Matched for Ease of Use
- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Excellent thermal stability, low HCI drift
- Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

Table 1. Maximum Ratings

| Rating | Symbol | Value | Unit |
|--------------------------------|------------------|-------------|------|
| DrainSource Voltage | V _{DSS} | 115 | Vdc |
| GateSource Voltage | V _{GS} | -10 to +10 | Vdc |
| Operating Voltage | V _{DD} | +55 | Vdc |
| Storage Temperature Range | Tstg | -65 to +150 | °C |
| Case Operating Temperature | T _c | +150 | °C |
| Operating Junction Temperature | T, | +225 | °C |

Table 2. Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|--|--------|-------|------|
| Thermal Resistance, Junction to Case, Case Temperature | | | |
| 80°C, 1000W Pout, Pulse width: 100us, duty cycle: 10%, | RеJC | 0.02 | °C/W |
| Vds=50 V, IDQ = 100 mA | | | |

Table 3. ESD Protection Characteristics

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| Test Methodology | Class |
|-----------------------------------|---------|
| Human Body Model (per JESD22A114) | Class 2 |

Table 4. Electrical Characteristics (TA = 25 °C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit | |
|--|------------------------------|-----|------|-----|------|--|
| DC Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | ., | | 445 | | ., | |
| $(V_{GS}=0V; I_D=100uA)$ | $V_{\scriptscriptstyle DSS}$ | | 115 | | V | |
| Zero Gate Voltage Drain Leakage Current | | | | 10 | | |
| $(V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V})$ | I _{DSS} | | | 10 | μА | |
| GateSource Leakage Current | | | | 1 | μА | |
| $(V_{GS} = 6 \text{ V}, V_{DS} = 0 \text{ V})$ | I _{GSS} | | | ' | μΑ | |
| Gate Threshold Voltage | V _{GS} (th) | | 1.6 | | V | |
| $(V_{DS} = 50V, I_D = 600uA)$ | V _{GS} (u1) | | 1.0 | | v | |
| Gate Quiescent Voltage | $V_{GS(Q)}$ | | 2.85 | | V | |
| $(V_{DD} = 50 \text{ V}, I_{DQ} = 600 \text{ mA}, \text{Measured in Functional Test})$ | V _{GS(Q)} | | 2.65 | | V | |

Functional Tests (In Yingtron test fixture, 50 ohm system) : V_{DD} = 50 Vdc, I_{DQ} = 100 mA, f = 1030 MHz, Pulse CW Signal Measurements. (Pulse Width=100 μ s, Duty cycle=10%)

| Power Gain @ P3dB | Gp | 15.2 | dB |
|-----------------------|----------------|------|-----|
| 3dB Compression Point | P3dB | 60.4 | dBm |
| Drain Efficiency@P3dB | η _D | 53.5 | % |
| Input Return Loss | IRL | -4 | dB |

Reference Circuit of Test Fixture Assembly Diagram

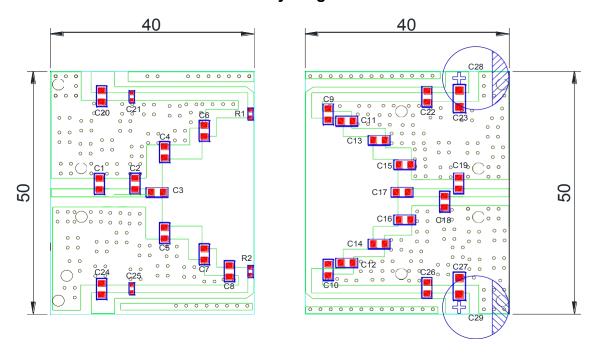


Figure 1. Test Circuit Component Layout

Table 1. Test Circuit Component Designations and Values

| Component | Description | Suggested Manufacturer | | | |
|-----------------|---|------------------------|--|--|--|
| C1 | 2.0pF | ATC800B | | | |
| C2 | 3.0pF | ATC800B | | | |
| C3,C17,C22,C26 | 39 pF | ATC800B | | | |
| C4,C5 | 3.3 pF | ATC800B | | | |
| C6,C7 | 2.2 pF | ATC800B | | | |
| C8,C9,C10 | 5.6 pF | ATC800B | | | |
| C11,C12,C13,C14 | 3.9 pF | ATC800B | | | |
| C15,C16,C18, | 2.7 pF | ATC800B | | | |
| C19 | 2.4 pF | ATC800B | | | |
| C21,C25 | 33 pF | ATC600F | | | |
| C20,C23,C24,C27 | Electrolytic Capacitor ,10uF,50V | | | | |
| R1,R2 | Chip Resistor,10 Ω ,0805 | | | | |
| C28,C29 | Electrolytic Capacitor ,470uF,63V | | | | |
| PCB | 0.762mm [0.030"] thick, εr=3.48, Rogers RO4350B, 1 oz. copper | | | | |

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TYPICAL CHARACTERISTICS

Condition: Vds = 50 V, Idq = 100 mA, Pulse width:100uS, duty cycle: 10%.

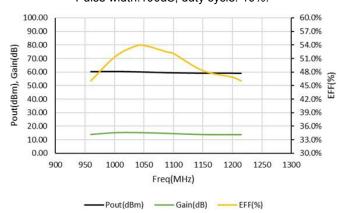
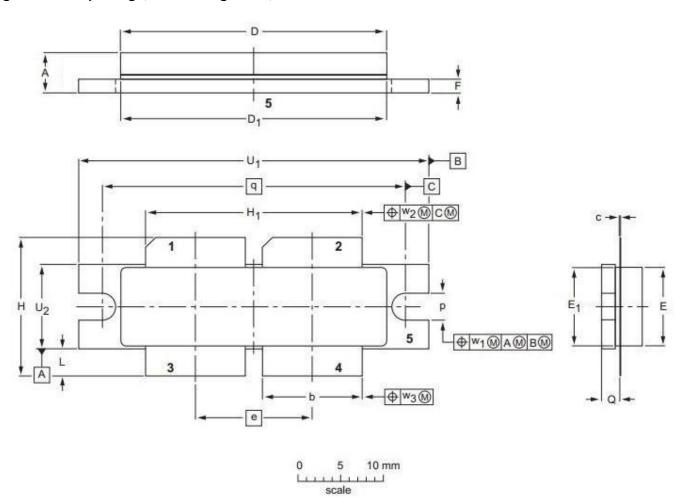


Figure 2. Power Gain and Drain Efficiency as Function of Pulse Output Power (960-1215MHz)

Package Outline

Flanged ceramic package; 2 mounting holes; 4 leads (1, 2—DRAIN, 3, 4—GATE, 5—SOURCE)



| UNIT | A | b | С | D | D ₁ | е | E | E ₁ | F | Н | H ₁ | L | р | q | q | U ₁ | U ₂ | W ₁ | W ₂ | W ₂ |
|--------|-------|-------|-------|-------|----------------|-------|-------|----------------|-------|-------|----------------|-------|-------|-------|-------|----------------|----------------|----------------|----------------|----------------|
| Mm | 4.7 | 11.81 | 0.18 | 31.55 | 31.52 | 13.72 | 9.50 | 9.53 | 1.75 | 17.12 | 25.53 | 3.48 | 3.30 | 2.26 | 35.56 | 41.28 | 10.29 | 0.25 | 0.51 | 0.25 |
| IVIIII | 4.2 | 11.56 | 0.10 | 30.94 | 30.96 | 13.72 | 9.30 | 9.27 | 1.50 | 16.10 | 25.27 | 2.97 | 3.05 | 2.01 | 33.30 | 41.02 | 10.03 | 0.25 | 0.51 | 0.25 |
| | 0.185 | 0.465 | 0.007 | 1.242 | 1.241 | | 0.374 | 0.375 | 0.069 | 0.674 | 1.005 | 0.137 | 0.130 | 0.089 | | 1.625 | 0.405 | | | |
| Inches | 0.165 | 0.455 | 0.004 | 1.218 | 1.219 | 0.540 | 0.366 | 0.365 | 0.059 | 0.634 | 0.995 | 0.117 | 0.120 | 0.079 | 1.400 | 1.615 | 0.395 | 0.01 | 0.02 | 0.01 |

| OUTLINE | | REFERENCE | | EUROPEAN | ISSUE DATE |
|---------|-----|-----------|-------|------------|------------|
| VERSION | IEC | JEDEC | JEITA | PROJECTION | 1000E DATE |
| PKG-D4E | | | | | 03/12/2013 |

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Revision history

Table 5. Document revision history

| Date | Revision | Datasheet Status |
|------------|----------|--------------------------------|
| 2018/10/12 | Rev 1.0 | Preliminary Datasheet Creation |

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